

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00878 REV: E1	SUN REU: Not In VersionControl
	TID #: TIDA-00878	
PLOT NAME = Top Assembly Drawing	GENERATED : 12/15/2015 5:33:31	PM TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00878 REV: E1	SVN REV: Not In VersionControl
	TID #: TIDA-00878	
PLOT NAME = Bottom Assembly Drawing	GENERATED : 12/15/2015 5:33:31	PM TEXAS INSTRUMENTS

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